CMOS Digital Integrated Circuits Silicon Monolithic

74LCX240FT

1. Functional Description

• Low-Voltage Octal Bus Buffer (Inverted) with 5-V Tolerant Inputs and Outputs

2. General

The 74LCX240FT is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation. The device is designed for low-voltage (3.3 V) $V_{\rm CC}$ applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

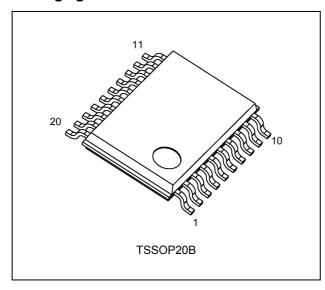
The 74LCX240FT is an inverting 3-state buffer having two active-low output enables. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

3. Features

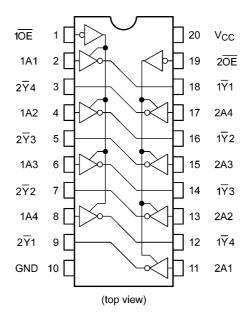
- (1) Low-voltage operation: $V_{CC} = 1.65$ to 3.6 V
- (2) High-speed operation: $t_{pd} = 6.5 \text{ ns (max)} (V_{CC} = 3.0 \text{ to } 3.6 \text{ V})$
- (3) Output current: $|I_{OH}|/I_{OL} = 24$ mA (min) ($V_{CC} = 3.0$ V)
- (4) Power-down protection provided on all inputs and outputs
- (5) Pin and function compatible with the 74 series (74LVC/ALVC/ etc.) 240 type

4. Packaging

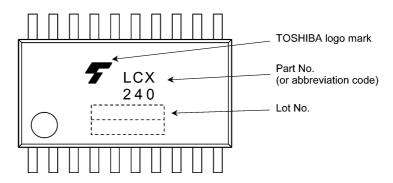




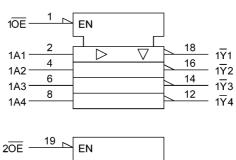
5. Pin Assignment



6. Marking



7. IEC Logic Symbol





8. Truth Table

Inputs OE	Inputs An	Outputs
L	L	Н
L	Н	L
Н	Х	Z

X: Don't care

Z: High impedance

9. Absolute Maximum Ratings (Note)

Characteristics		Note	Rating	Unit
Supply voltage	V _{CC}		-0.5 to 6.5	V
Input voltage	V _{IN}		-0.5 to 6.5	V
Output voltage	V _{OUT}	(Note 1)	-0.5 to 6.5	V
		(Note 2)	-0.5 to V _{CC} + 0.5	
Input diode current	I _{IK}		-50	mA
Output diode current	I _{OK}	(Note 3)	±50	mA
Output current	l _{out}		±50	mA
Power dissipation	P _D		180	mW
V _{CC} /ground current	I _{CC} /I _{GND}		±100	mA
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Output in OFF state.

Note 2: High (H) or Low (L) state. I_{OUT} absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

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10. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V _{CC}		1.65 to 3.6	V
		(Note 1)	1.5 to 3.6	
Input voltage	V _{IN}		0 to 5.5	V
Output voltage	V _{OUT}	(Note 2)	0 to 5.5	V
		(Note 3)	0 to V _{CC}	
Output current	I _{OH} ,I _{OL}	(Note 4)	±24	mA
		(Note 5)	±12	
Operating temperature	T _{opr}		-40 to 85	°C
Input rise and fall times	dt/dv	(Note 6)	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either V_{CC} or GND.

Note 1: Data retention only.

Note 2: Output in OFF state.

Note 3: High or low state

Note 4: V_{CC} = 3.0 to 3.6 V

Note 5: V_{CC} = 2.7 to 3.0 V

Note 6: V_{IN} =0.8 to 2.0 V , V_{CC} = 3.0 V

11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, T_a = -40 to 85°C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		1.65 to 2.3	$V_{CC} \times 0.9$	_	V
				2.3 to 2.7	1.7	_	
				2.7 to 3.6	2.0		
Low-level input voltage	V _{IL}	_		1.65 to 2.3	_	$V_{CC} \times 0.1$	V
				2.3 to 2.7	_	0.7	
				2.7 to 3.6	_	0.8	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I_{OH} = -100 μ A	1.65 to 3.6	V _{CC} - 0.2		V
			I_{OH} = -4 mA	1.65	1.05		
			I_{OH} = -8 mA	2.3	1.7		
			I_{OH} = -12 mA	2.7	2.2		
			I_{OH} = -18 mA	3.0	2.4		
			I _{OH} = -24 mA	3.0	2.2		
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.65 to 3.6	_	0.2	V
			I_{OL} = 4 mA	1.65	_	0.45	
			I_{OL} = 8 mA	2.3	_	0.7	
			I _{OL} = 12 mA	2.7	_	0.4	
			I _{OL} = 16 mA	3.0	_	0.4	
			I _{OL} = 24 mA	3.0	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μΑ
3-state output OFF-state leakage current	l _{OZ}	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 3.6	_	±5.0	μА
Power-OFF leakage current	I _{OFF}	V _{IN} /V _{OUT} = 5.5 V		0	_	10.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0	μА
		V _{IN} /V _{OUT} = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	
Quiescent supply current	Δl _{CC}	V _{IH} = V _{CC} - 0.6 V (per input)		2.7 to 3.6	_	500	μА



11.2. AC Characteristics (Unless otherwise specified, T_a = -40 to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}		See 11.5 AC Test Circuit,	1.8 ± 0.15	_	25.0	ns
			Table 11.5.1, Fig. 11.6.1, Table 11.6.1	2.5 ± 0.2		8.5	
			11.0.1	2.7		7.5	
				3.3 ± 0.3	1.5	6.5	
3-state output enable time	t _{PZL} ,t _{PZH}		See 11.5 AC Test Circuit, Table 11.5.1, Fig. 11.6.2, Table 11.6.1	1.8 ± 0.15		32.0	ns
				2.5 ± 0.2		16.0	
				2.7	_	9.0	
				3.3 ± 0.3	1.5	8.0	
3-state output disable time	t _{PLZ} ,t _{PHZ}		See 11.5 AC Test Circuit, Table 11.5.1, Fig. 11.6.2, Table 11.6.1	1.8 ± 0.15		30.0	ns
				2.5 ± 0.2	_	15.0	
				2.7	_	8.0	
				3.3 ± 0.3	1.5	7.0	
Output skew	t _{osLH} ,t _{osHL}	(Note 1)	_	2.7	1		ns
				3.3 ± 0.3	_	1.0	

Note 1: Parameter guaranteed by design. ($t_{osLH} = |t_{PLH}m - t_{PLH}n|$, $t_{osHL} = |t_{PHL}m - t_{PHL}n|$)

11.3. Dynamic Switching Characteristics (Unless otherwise specified, T_a = 25°C, Input: t_r = t_f = 2.5 ns, C_L = 50 pF, R_L = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	V _{IH} = 3.3 V, V _{IL} = 0 V	3.3	0.8	V

11.4. Capacitive Characteristics (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}			3.3	7	pF
Output capacitance	C _{OUT}			3.3	8	pF
Power dissipation capacitance	C _{PD}	(Note 1)	f _{IN} = 10 MHz	3.3	25	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8$ (per bit)

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11.5. AC Test Ciruict

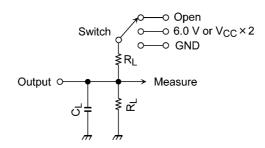


Table 11.5.1 Parameter for AC Test Circuit

Parameter	Switch	Test Condition
t _{PLH} , t _{PHL}	OPEN	_
t _{PLZ} , t _{PZL}	6.0 V	V_{CC} = 3.3 ± 0.3 V
		V _{CC} = 2.7 V
	V _{CC} × 2	V_{CC} = 2.5 \pm 0.2 V
		V _{CC} = 1.8 ± 0.15 V
t _{PHZ} , t _{PZH}	GND	_



11.6. AC Waveform

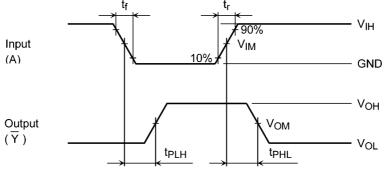


Fig. 11.6.1 t_{PLH}, t_{PHL}

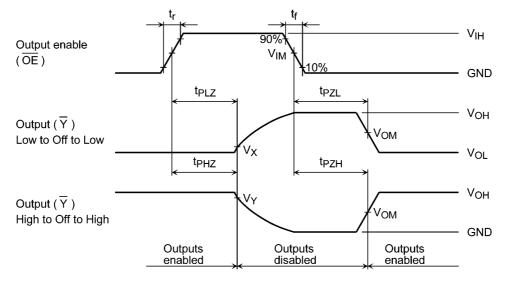


Fig. 11.6.2 tpLZ, tpHZ, tpZL, tpZH

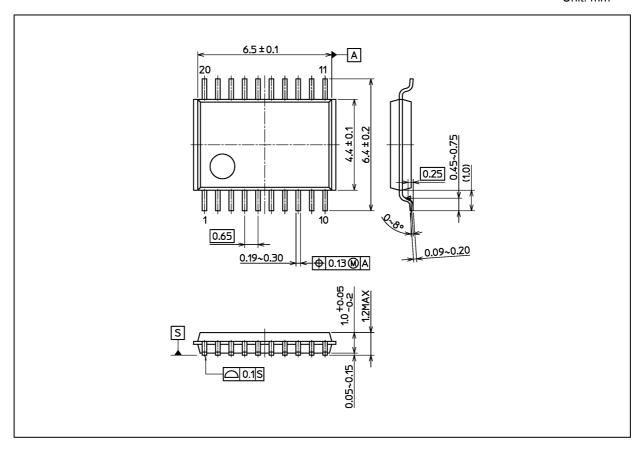
Table 11.6.1 AC Waveform Symbols

	Symbol	$V_{CC} = 3.3 \pm 0.3 \text{ V}$ $V_{CC} = 2.7 \text{ V}$	V_{CC} = 2.5 ± 0.2 V	V _{CC} = 1.8 ± 0.15 V
Input	V _{IH}	2.7 V	V _{CC}	V _{CC}
	V _{IM}	1.5 V	V _{CC} /2	V _{CC} /2
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2
	V _X	V _{OL} + 0.3 V	V _{OL} + 0.15 V	V _{OL} + 0.15 V
	V_{Y}	V _{OH} - 0.3 V	V _{OH} - 0.15 V	V _{OH} - 0.15 V
Load	C _L	50 pF	30 pF	30 pF
	R_L	500 Ω	500 Ω	1 kΩ



Package Dimensions

Unit: mm



Weight: 0.071 g (typ.)

Package Name(s)
Nickname: TSSOP20B



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